

EAST Search History**EAST Search History (Prior Art)**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	8091	204/280-297.01.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/06/25 14:47
L2	49	1 and (substrate with (hole or cavit\$3 or depression) with (electrode or microdisk or metallization))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/06/25 14:48
L11	1	"10586668"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/06/25 14:56
L12	32	(jean with gobet).in. or (Niedermann with Philippe).in. or (Rychen with Philippe).in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/06/25 14:57
L13	10	(ADAMANT with TECHNOLOGIES).as.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/06/25 14:58
S1	12783	electrode near5 substrate near5 (cavit\$5 or pier\$5 or hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/04 12:56
S2	0	"electrode located on a substrate" near5 (cavit\$5 or pier\$5 or hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/04 12:57
S3	4	S1 and microdisk	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/04 12:57
S4	9	recessed near5 microdisk near5 electrode	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/04 12:58
S5	2	S4 and diamond	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/04 12:59
S6	0	(microdisk adj electrode) near5 substrate near5 (cavit\$5 or pier\$5 or hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 13:40
S7	0	(microdisc adj electrode) near5 substrate near5 (cavit\$5 or pier\$5 or hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 13:40

S8	12809	electrode near5 substrate near5 (cavit\$5 or pier\$5 or hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 13:40
S9	3614	S8 and (conductiv\$5 near5 substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 13:40
S10	142	S9 and (micro near5 electrode)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 13:41
S11	1	"hole in substrate"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 13:48
S12	1790	216/13.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 14:00
S13	687	216/13.ccls. and (etch\$5 near5 substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 14:01
S14	359	S13 and @py<"2004"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 14:01
S15	148	S14 and (electrode or anode or cathode)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 14:01
S16	2	("4874500").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2009/12/14 14:35
S17	1	"10478749"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/12/14 15:43
S18	1	"10586668"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/06/25 13:27
S19	7936	204/280-296.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/06/25 13:45

EAST Search History (Interference)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	6653	204/280-297.01.ccls.	USPAT; UPAD	OR	ON	2010/06/25 14:49
L4	25	3 and (substrate with (hole or cavit\$3 or depression) with (electrode or microdisk or metallization))	USPAT; UPAD	OR	ON	2010/06/25 14:49

L5	3222	(substrate with (hole or cavit\$3 or depression) with (electrode or microdisk or metallization)).clm.	USPAT; UPAD	OR	ON	2010/06/25 14:53
L6	798	(conduct\$5 with \substrate with (hole or cavit\$3 or depression) with (electrode or microdisk or metallization)).clm.	USPAT; UPAD	OR	ON	2010/06/25 14:53
L7	798	(conduct\$5 with substrate with (hole or cavit\$3 or depression) with (electrode or microdisk or metallization)).clm.	USPAT; UPAD	OR	ON	2010/06/25 14:53
L8	300	(conduct\$5 near3 substrate with (hole or cavit\$3 or depression) with (electrode or microdisk or metallization)).clm.	USPAT; UPAD	OR	ON	2010/06/25 14:53
L9	8	(conduct\$5 near3 substrate with (hole or cavit\$3 or depression) with array with (electrode or microdisk or metallization)).clm.	USPAT; UPAD	OR	ON	2010/06/25 14:54
L10	10	(conduct\$5 near3 substrate with (hole or cavit\$3 or depression) with (multiple or plurality or array) with (electrode or microdisk or metallization)).clm.	USPAT; UPAD	OR	ON	2010/06/25 14:54

6/25/2010 3:03:43 PM

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